RE 10-27-	·2004 3T		
To the Honorable Commissioner for Patents	nt	(s) or copy(ies) thereof.	0
1. Name of Conveying Party(ies): Torkel Arnborg Ulf Smith		(c) or supplies, moreon	587 U.S.
Additional name(s) of conveying party(ies) attac	hed? Yes	X No	6 =
2. Name and Address of Party(ies) receiving an interest (assignee(s)): Name: Infineon Technologies AG Address: StMartin-Str. 53, 81669 München Country: GERMANY Additional name(s) and address(es) attached? Yes X No			
3. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date(s) of the application is: October 19, 2004 A. Patent Application No(s).: Patent No(s).:			
Others on additional sheet(s) attached?		Yes X No	
4. Nature of Conveyance: X ASSIGNMENT Merger Verified Translation Security Agreement Execution Date: 09/10/04 (Arnborg); 09/16/04(Smith)	Change of Other:		
5. Name and address of party to whom correspondence concerning document should be mailed: ANDREAS GRUBERT BAKER BOTTS L.L.P. (023640) ONE SHELL PLAZA 910 LOUISIANA STREET HOUSTON, TEXAS 77002-4995 713.229.1964 (TELEPHONE) 713.229.7764 (FACSIMILE)	6. Total number of Application(s): + Patent(s): = Total: 7. Total Fee (37 C.F.F. CHECK IS 8. Authorized to be check 9. Deposit Account N (Dupl Charge any un	applications and patents 1 1 R. § 3.41) \$40.00 ENCLOSED. harged to Deposit Account N	ed) verpayment
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10. Statement and Signature To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.			
Bruce W. Slayden II Name of Person Signing	Saydin II Signature	OCTOBER 1 Date	<u>9, 2004</u>
Total number of pages including cover sheet, attachments, and document: 3 PAGES			
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Via Express Mail No. EV448728540US PATENT

ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we, the below signed inventors of record, hereby assign to:

Infineon Technologies AG ST.-MARTIN-STRASSE 53 D-81669 MÜNCHEN GERMANY

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and interest throughout the world in the inventions and improvements which are the subject of an application for United States Patent signed by me this day, entitled:

LDMOS TRANSISTOR DEVICE, INTEGRATED CIRCUIT, AND FABRICATION METHOD THEREOF

this assignment including said application, any and all United States and foreign patents, utility models, design registrations, inventor's certificates and other similar rights granted for any of said inventions or improvements, and the right to claim priority based on the filing date of said application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and I authorize the Assignee to apply in all countries in my name, or in its own name, for patents, utility models, design registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements; and I agree for myself and my heirs, legal representatives and assigns, without further compensation to perform such lawful acts and to sign such further applications, assignments, Preliminary Statements and other lawful documents as the Assignee may reasonably request to effectuate fully this assignment.

IN WITNESS THEREOF, I hereby set my hand, date of signature and place of signature as indicated below.

Full Name of First Inventor: Torkel ARNBORG Residence: Stockholm, Sweden

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Signature of Sole or First Inventor

/0.9, 2009
Date of Signature

Ham Nort-

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PATENT REEL: 015933 FRAME: 0737 Full Name of Second Joint Inventor: Ulf SMITH

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Signature of Second Joint Inventor

Date of Signature

16.9.2004

Witness

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RECORDED: 10/19/2004

PATENT REEL: 015933 FRAME: 0738